## 507054090 01/03/2022

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT7100928

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
Yoshiyuki Kurokawa	06/25/2015

### **RECEIVING PARTY DATA**

Name:	SEMICONDUCTOR ENERGY LABORATORY CO., LTD.
Street Address:	398, HASE
City:	ATSUGI-SHI, KANAGAWA-KEN
State/Country:	JAPAN
Postal Code:	243-0036

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	17567234

#### **CORRESPONDENCE DATA**

**Fax Number:** (877)769-7945

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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 (214) 292-4040

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ATTORNEY DOCKET NUMBER:	12732-1545004
NAME OF SUBMITTER:	SHARON M. ALLEN
SIGNATURE:	/Sharon M. Allen/
DATE SIGNED:	01/03/2022

**Total Attachments: 1** 

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PATENT 507054090 REEL: 058525 FRAME: 0620

Attorney Docket No. 12732-1545002 Client Ref. No. US20866-C1

# **ASSIGNMENT**

For valuable consideration, I, <u>Yoshiyuki KUROKAWA of Sagamihara, Kanagawa, Japan</u> hereby assign to <u>Semiconductor Energy Laboratory Co., Ltd.</u>, a <u>Japanese</u> corporation having a place of business at:

398, Hase, Atsugi-shi, Kanagawa-ken, 243-0036 Japan

and its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title and
interest throughout the world in the inventions and improvements which are subject of an application for
United States Patent signed by me this day, entitled <u>DRIVING METHOD OF SEMICONDUCTOR</u>
DEVICE AND ELECTRONIC DEVICE, filed July 2, 2015 , and assigned U.S. Serial
Number 14/790,801 , and I authorize and request the Assignee or the attorneys appointed in
said application to hereafter complete this assignment by inserting above the filing date and serial number of
said application when known; this assignment including said application, any and all United States and
foreign patents, utility models, and design registrations granted for any of said inventions or improvements,
and the right to claim priority based on the filing date of said application under the International Convention
for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and
all other treaties of like purposes; and I authorize the Assignee to apply in all countries in my name or in its
own name for patents, utility models, design registrations and like rights of exclusion and for inventors'
certificates for said inventions and improvements; and I agree for myself and my respective heirs, legal
representatives and assigns, without further compensation to perform such lawful acts and to sign such
further applications, assignments, Preliminary Statements and other lawful documents as the Assignee may
reasonably request to effectuate fully this assignment.

Signature <u>Yashiyuki Kurokawa</u>

Name: Yoshiyuki KUROKAWA

Date: 0b/25/20/5

**RECORDED: 01/03/2022** 

PATENT REEL: 058525 FRAME: 0621